

FORM PTO-1449(Modified) LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT	ATTY. DOCKET NO. H0498/7085	SERIAL NO. 09/094,074
	APPLICANT Rebecca J. Jackman et al.	
	FILING DATE October 20, 2000	GROUP

U.S. PATENT DOCUMENTS

Exam Init	Ref Des	Document No.	Date	Name	Class	Sub Class	FILING DATE If Appropriate
	1	4,093.754	06/06/78	Parsons	—	—	—
	2	4,493.757	01/15/85	Piepers	—	—	—
	3	4,518.636	05/21/85	Richards	—	—	—
	4	4,527.988	07/09/85	Lutz et al.	—	—	—
	5	4,777.117	11/11/88	Murata et al.	—	—	—
	6	5,147.763	09/15/92	Kamitakahara	—	—	—
	7	5,155.749	10/13/92	DiMilia et al.	—	—	—
	8	5,160.959	11/03/92	Everett et al.	—	—	—
	9	5,259.926	11/09/93	Kuwabara et al.	—	—	—
	10	5,480.530	01/02/96	Zejda	—	—	—
	11	5,665.496	09/09/97	Omika et al.	—	—	—
	12	5,691.018	11/25/97	Kelley et al.	—	—	—
	13	5,705.043	01/06/98	Zwerner et al.	—	—	—

FOREIGN PATENT DOCUMENTS

		Country & Doc. No. (11)	Pub. Date (43)		Class	Sub Class	Translation Yes No
	14	DE 38 41 317	13.06.90	Nokia Unterhaltungselektronick	—	—	—
	15	DE 33 31 377	07.03.85	Messerschmitt, Elmar, Dr.	—	—	—
	16	GB 2 201 637	07.09.88	ERA Patents Limited	—	—	—
	17	WO 99/54786	28.10.99	President and Fellows of Harvard College	—	—	—

OTHER ART

(Including Author, Title, Date, Pertinent Pages, Publication, Etc.)

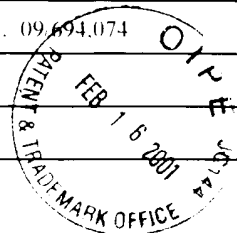
	18		Patent Abstracts of Japan, Vol. 014, No. 544
	19		X.D. Xiang et al., "A Combinatorial Approach to Materials Discovery", <i>Science</i> , Vol. 268, 23 June 1995, pgs. 1738-1740.
	20		Author Unknown, "Lift Off Technique for High Temperature Metal Depositions", <i>IBM Technical Disclosure Bulletin</i> , December 1972, Vol. 15, No. 7, pg. 2305.
	21		P. Yam, "Plastics Get Wired", <i>Scientific American</i> , July 1995, pgs. 83-87.
	22		E. M. Kirschner, "Electronic Chemicals", <i>C&EN</i> , November 24, 1997, pgs. 25-39.
	22		G. J. Burger et al., "High-resolution shadow-mask patterning in deep holes and its application to an electrical wafer feed-through", <i>Sensors and Actuators, A</i> 54, 1996, pgs. 669-673.
	23		S. Noach et al., "Microfabrication of an electroluminescent polymer light emitting diode pixel array", <i>Appl. Phys. Lett.</i> , 69 (24), 9 December 1996, pgs. 3650-3652.

* a copy of this reference is not provided as it was previously cited by or submitted to the office in a prior application, Serial No. _____, filed _____, and relied upon for an earlier filing date under 35 U.S.C. 120 (continuation, continuation-in-part, and divisional applications).

Examiner	DATE CONSIDERED 4/21/03
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered.

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(Including Author, Title, Date, Pertinent Pages, Publication, Etc.)

24	M. Renak et al., "Microlithographic Process for Patterning Conjugated Emissive Polymers", <i>Advanced Materials</i> , 1997, 9, No. 5, pgs. 392-394.
25	M. Granstrom et al., "Flexible Arrays of Submicrometer-Sized Polymeric Light Emitting Diodes", <i>Advanced Materials</i> , 1995, 7, No. 12, pgs. 1012-1015.
26	M. Granstrom et al., "Micrometer-and Nanometer-Sized Polymeric Light-Emitting Diodes", <i>Science</i> , Vol. 267, 10 March 1995, pgs. 1479-1481.
27	Z. Bao et al., "High-Performance Plastic Transistors Fabricated by Printing Techniques", <i>Chem. Mater.</i> 1997, 9, Pgs. 1299-1301.
28	W. W. Clegg et al., "The preparation of piezoceramic-polymer thick films and their application as micromechanical actuators", <i>Sensors and Actuators, A</i> 58 (1997) pgs. 173-177.
29	H. Goldberg et al., "Screen printing: a technology for the batch fabrication of integrated chemical-sensor arrays", <i>Sensors and Actuators, B</i> 21 (1994) pgs. 171-183.
30	F. Garnier et al., "All-Polymer Field-Effect Transistor Realized by Printing Techniques", <i>Science</i> , Vol. 265, 16 September 1994, pgs. 1684-1686.
31	Y. Mikami et al., "A New Patterning Process Concept for Large-Area Transistor Circuit Fabrication Without Using an Optical Mask Aligner", <i>IEEE</i> , Vol. 41, No. 1, March 1994.
32	H. Lorenz et al., "Low-cost technology for multilayer electroplated parts using laminated dry film resist", <i>Sensors and Actuators, A</i> 53 (1996) pgs. 364-368.
33	S. Leppavuori et al., "A novel thick-film technique, gravure offset printing, for the realization of fine-line sensor structures", <i>Sensors and Actuators, A</i> 41-42 (1994) pgs. 593-596.
34	V. Golovanov et al., "Different thick-film methods in printing of one-electrode semiconductor gas sensors", <i>Sensors and Actuators, B</i> 34 (1996) pgs. 401-406.
35	Y. Kijima et al., "RGB Luminescence from Passive-Matrix Organic LED's", <i>IEEE</i> , Vol. 44, No. 8, August 1997, pgs. 1222-28.
36	Z. Shen et al., "Three-Color, Tunable, Organic Light-Emitting Devices", <i>SCIENCE</i> , Vol. 276, June 27, 1997, pgs. 2009-11.
37	P. E. Burrows et al., "Achieving Full-Color Organic Light-Emitting Devices for Lightweight, Flat-Panel Displays", <i>IEEE</i> , Vol. 44, No. 8, August 1997, pgs. 1188-1203.
38	G. Gustfsson et al., "Flexible light-emitting diodes made from soluble conducting polymers", <i>Nature</i> , Vol. 357, June 11, 1992, pgs. 477-79.
39	J. Wang et al., "Identification of a Blue Photoluminescent Composite Material from a Combinatorial Library", <i>SCIENCE</i> , Vol. 279, March 13, 1998, pgs. 1712-14.

* a copy of this reference is not provided as it was previously cited by or submitted to the office in a prior application, Serial No. _____, filed _____, and relied upon for an earlier filing date under 35 U.S.C. 120 (continuation, continuation-in-part, and divisional applications).

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